

## HSBC HONG KONG SCHOLARSHIP 2022/23 APPLICATION FORM

### APPLICANT'S PERSONAL INFORMATION

Family name: \_\_\_\_\_ First name: \_\_\_\_\_  
 Chinese name, if any: \_\_\_\_\_ Preferred name: \_\_\_\_\_  
 Birth date: \_\_\_\_\_ Gender: \_\_\_\_\_ First 5 digits of HK I/D: \_\_\_\_\_  
 Are you a permanent citizen (If not born in Hong Kong\*) \*No. of years living  
 of Hong Kong? \_\_\_\_\_ \*Place of birth: \_\_\_\_\_ in Hong Kong: \_\_\_\_\_  
 Home address: \_\_\_\_\_  
 Contact number: \_\_\_\_\_ Permanent e-mail address: \_\_\_\_\_  
 Parents' occupations: \_\_\_\_\_  
 Monthly family<sup>1</sup> income<sup>2</sup> (HKD): \_\_\_\_\_ Number of family members: \_\_\_\_\_  
 Are you a government grant recipient? \_\_\_\_\_ Grant amount (HKD): \_\_\_\_\_  
 Scholarship awards received, including any from HSBC (e.g. NAME OF SCHOLARSHIP, YEAR):  
 \_\_\_\_\_

Please affix  
recent photo here

### EDUCATIONAL BACKGROUND

Name of university: \_\_\_\_\_ Current year of study: \_\_\_\_\_  
 Name of programme: \_\_\_\_\_  
 GPA score: \_\_\_\_\_  
                                 CGPA                  2022/23 1<sup>st</sup> term                  2021/22 (if applicable)

**Name of secondary school or any other post-secondary school attended:**  
*(Please list in chronological order from the most recent to the earliest.)*

From	To	School

**Community service, if any.**  
*(Please list a maximum of 3 in chronological order from the most recent to the earliest.)*

From	To	Description

**Work experience, if any.**  
*(Please list a maximum of 3 in chronological order from the most recent to the earliest.)*

From	To	Company / organisation	Title / capacity	Full-time/ part-time

<sup>1</sup> "Family" means the applicant, applicant's spouse, parents, siblings, children and any other persons who are financially dependent on the aforementioned members.  
<sup>2</sup> Please note that the applicant may be required to submit supporting documentation to substantiate his/her declaration.

**PERSONAL ESSAY**

**INSTRUCTIONS: PLEASE ATTACH YOUR ANSWER TO THE ESSAY IN ENGLISH USING NO MORE THAN 500**

Essay: Please tell us about (1) your career aspirations and how an HSBC scholarship will open up a world of opportunity for you; and (2) your financial needs.

**DECLARATION BY THE APPLICANT**

I, \_\_\_\_\_ (Name in full), understand that I am required to disclose anything that may be considered to be an actual or potential conflict of interest with regard to my application for an HSBC Scholarship. Examples of potential conflicts of interest include, but are not limited to, previous or current student apprenticeships with HSBC and having close relatives<sup>3</sup> or individuals with whom the applicant has a personal relationship<sup>4</sup> with working in HSBC.

I declare that:

I have no actual or potential conflict of interest that could directly or indirectly affect my application for an HSBC Scholarship. I will report such actual or potential conflict of interest should it arise.

I have held the following position in HSBC and/or have a close relative or someone with whom I have a personal relationship with in HSBC. I provide the relevant information below for your assessment of conflict of interest:

Student internship/ placement in HSBC:

Department: \_\_\_\_\_

Internship period: \_\_\_\_\_

Name of supervisor: \_\_\_\_\_

Close relatives or those with whom the applicant has a personal relationship with working in HSBC:

Name: \_\_\_\_\_

Job title: \_\_\_\_\_

Relationship to applicant: \_\_\_\_\_

Any other actual or potential conflict of interest:

\_\_\_\_\_

<sup>3</sup> "Close relative" means spouse, parents, step parents, siblings, step siblings, children, step children, grandparents or the spouse of any of these and aunts, uncles, nephews or nieces.

<sup>4</sup> "Personal relationship" means relationships with family members, friends and partnerships.

## **PERSONAL INFORMATION COLLECTION STATEMENT**

### **Purpose of collection**

The personal data provided in this form and any other information (the “Information”) that may be provided for the purposes of the application for “HSBC Hong Kong Scholarship 2022/23” (the “Programme”) and the enrolment for “The Hub for the Future” (the “Hub”) will be used by the Hongkong Bank Foundation (the “Foundation”) and The Hongkong and Shanghai Banking Corporation Limited (“HSBC”) and their agents/contractors for one or more of the following purposes and any directly related purpose, in respect of the Programme and the Hub:

- (i) to consider, process and administer your application, and serve any directly related purposes, e.g. processing and administering the scholarship under the Programme (if granted), and to communicate with you.
- (ii) to be contacted by the Hub (if granted)
  - a. to check, verify and maintain the Members’ status;
  - b. to keep and update the Members’ contact records;
  - c. to communicate with and provide updates and information to you;
  - d. to inform you of or invite you to events, activities and programmes of or organised by the Hub or other events, activities and programmes considered by the Hub to be relevant to or of interest to Members;
  - e. to compile statistics and conduct research of the operation of the Hub
- (iii) any other purposes as may be required, authorised or permitted by any law and/or regulation.

It is voluntary for you to provide your personal data to the Foundation and HSBC. If you fail to supply any of the Information required by this form, your application may not be processed.

### **Access to personal data**

Except where there is an exemption provided under the Personal Data (Privacy) Ordinance (Cap. 486), you have the right to request access to and correction of your personal data provided in this form when the data have not been erased. Your right of access includes the right to obtain a copy of your personal data provided in this form subject to payment of a fee.

### **Request and enquiry**

Your request for access to personal data or enquiry regarding personal data privacy policy should be addressed to:

The Data Protection Officer  
The Hongkong and Shanghai Banking Corporation Limited  
PO Box 72677  
Kowloon Central Post Office  
Hong Kong  
Re: HSBC Hong Kong Scholarship 2022/23  
E-mail: [dfv.enquiry@hsbc.com.hk](mailto:dfv.enquiry@hsbc.com.hk)

I declare that the Information provided in this Scholarship application is accurate, true and complete to the best of my knowledge. I am aware that the Hongkong Bank Foundation/HSBC will rely on such Information and consent to the Hongkong Bank Foundation/HSBC relying on the Information provided by me to determine my eligibility for the scholarship and the amount of the scholarship to be offered to me.

I confirm that I have carefully read and fully understand the “Personal Information Collection Statement” (the “PICS”) set out above. I accept the PICS and the purposes of use of the Information set out in it.

I confirm that each of the family members and other persons in respect of which the Information is provided in or in relation to this application (the “Relevant Person(s)”) has been notified of and agreed to the PICS and the purposes of use of the Information set out in it. I shall advise each Relevant Person that he/she has rights of access to, and correction of, his/her personal data. I agree to inform the Foundation/HSBC promptly in writing if I am not able or have failed to comply with the obligations set out in this paragraph in any respect.

I authorise and consent to my university releasing my personal data held by it to the Foundation/HSBC in order for it to use such information for such purposes set out in the PICS.

I authorise the Foundation to (i) transfer the Information to HSBC and for HSBC to use the Information for such purposes set out in the PICS; and (ii) release the results of my application to my university or institution.

Signature of the Applicant:

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Name in full:

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First 5 digits of HK I/D:

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Date:

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**TO BE COMPLETED BY THE UNIVERSITY**

**SUPPLEMENTARY INFORMATION FROM UNIVERSITY (OPTIONAL)**

UNIVERSITIES MAY ATTACH A ONE PAGE DOCUMENT TO PROVIDE ANY SUPPLEMENTARY INFORMATION ABOUT THE APPLICANT. (e.g. Recommendations from the university, personal qualities not captured by the form, any special learning needs, family background, etc.)

I certify that the above-named applicant has been interviewed by our selection process and he/she is considered eligible for the Programme.

I understand that the information collected will be kept confidential and used by the Foundation/ HSBC to process the scholarship application and for the purposes set out in the PICS above. The Foundation/ HSBC will not disclose the information collected to any external organisation (other than as stated in the PICS attached in this document) unless we have the Applicant's and our consent or are required by law.

Signature: \_\_\_\_\_  
*(signature with official chop)*

Date: \_\_\_\_\_

Name: \_\_\_\_\_

Official Chop

Title: \_\_\_\_\_